Notes:
1. 5-Layer Flex, Material 8F775
2. Min trace/space - .01"
3. 0.3 oz. copper on all layers
4. Silk screen on component side
5. Polyimide Coverlay (Capton Soldermask) on top and bottom
6. Soft Au finish (EUA) for all wirebonding and hand soldering on all pads
7. Piece stiffener on bottom side
8. Total thickness 0.012", not including stiffener

DAMIC - Die Test Flex - Rev A
SRC-540
10/13/2023
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